



P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)			
- 30	0.0068 at V _{GS} = - 10 V	- 22			

FEATURES

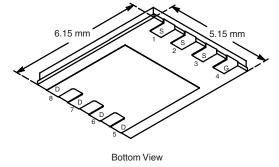
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFETs
- New Low Thermal Resistance PowerPAK[®]
 Package with Low 1.07 mm Profile





APPLICATIONS

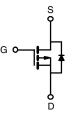
- · Battery and Load Switching
 - Notebook Computers
 - Notebook Battery Packs



PowerPAK SO-8

Ordering Information: Si7459DP-T1-E3 (Lead (Pb)-free)

Si7459DP-T1-GE3 (Lead (Pb)-free and Halogen-free)



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 ^{\circ}C$, unles	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	- 30		V
Gate-Source Voltage		V_{GS}	± 25		V
Continuous Drain Current /T 150°C\2	T _A = 25 °C	- I _D	- 22	- 13	А
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70 °C		- 17	- 10	
Pulsed Drain Current		I _{DM}	- 60		A
Continuous Source Current (Diode Conduction) ^a		I _S	- 4.5 - 1.6		
Marrian David Disable ation 8	T _A = 25 °C	P _D	5.4	1.9	W
Maximum Power Dissipation ^a	T _A = 70 °C		3.4	1.2	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{b,c}		260		C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian de Austriant	t ≤ 10 s	- R _{thJA}	18	23	
Maximum Junction-to-Ambient ^a	Steady State		' 'thJA	52	65
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	1.0	1.5	

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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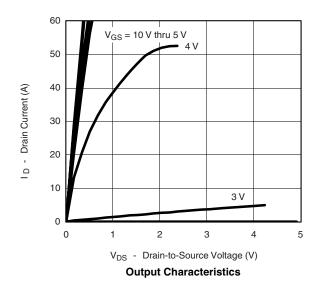
SPECIFICATIONS T _J = 25 °C, unless otherwise noted										
Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit				
Static										
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$			- 3.0	V				
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA				
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$			± 200	IIA				
Zero Gate Voltage Drain Current		V _{DS} = - 30 V, V _{GS} = 0 V			- 1					
	I _{DSS}	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 ^{\circ}\text{C}$			- 10	μΑ				
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 30			Α				
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 22 A		0.0056	0.0068	Ω				
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 22 A		50		S				
Diode Forward Voltage ^a	V _{SD}	I _S = - 2.9 A, V _{GS} = 0 V		- 0.71	- 1.1	V				
Dynamic ^b										
Total Gate Charge	Q_g			113	170	nC				
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 10 V, I_D = - 22 A		17						
Gate-Drain Charge	Q_{gd}			32.5						
Turn-On Delay Time	t _{d(on)}			25	40					
Rise Time	t _r	V_{DD} = - 15 V, R_L = 15 Ω		20	30	ns				
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 1 A, V_GEN = - 10 V, R_g = 6 Ω		180	270					
Fall Time	t _f			130	200					
Gate Resistance	R_g			4		Ω				
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 2.9 A, dl/dt = 100 A/μs		100	150	ns				

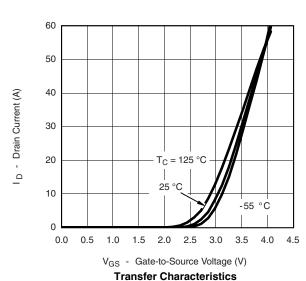
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



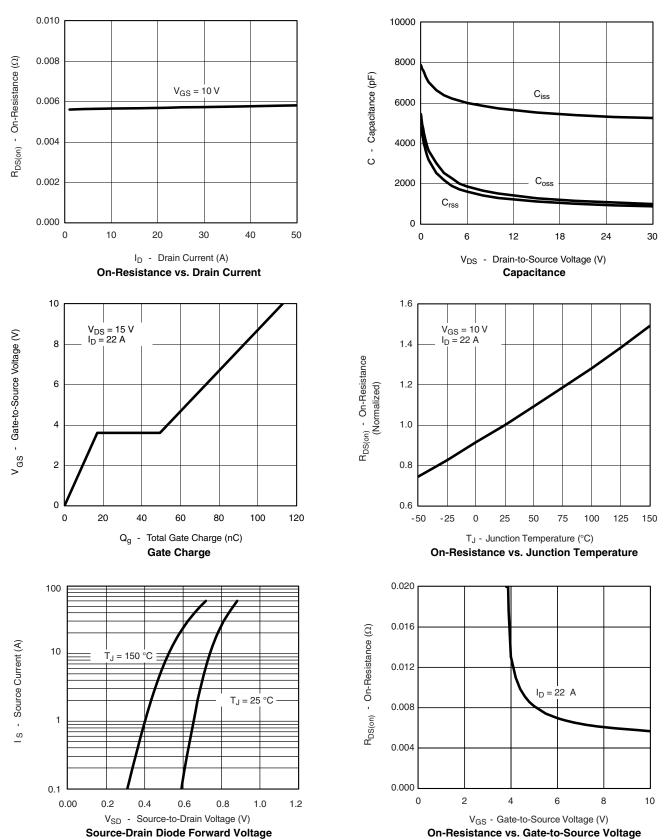








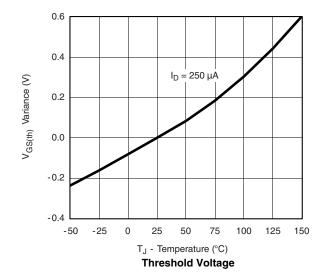
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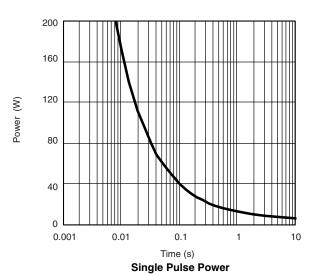


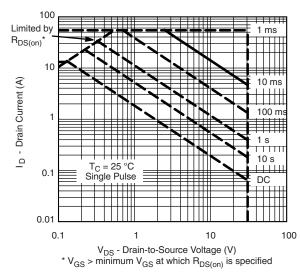
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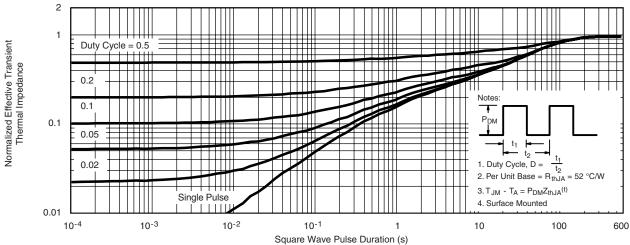
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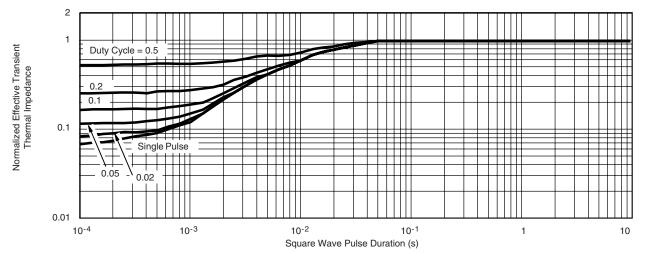




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

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